



# Application Notes: AN\_SY8366A

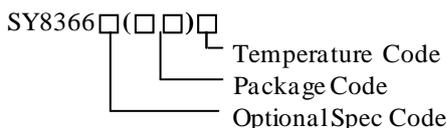
## High Efficiency Fast Response 6A Continuous, 12A Peak, 28V Input Synchronous Step Down Regulator

### General Description

The SY8366A develops a high efficiency synchronous step-down DC-DC regulator capable of delivering 6A continuous, 12A peak current. The SY8366A operates over a wide input voltage range from 4V to 28V and integrates main switch and synchronous switch with very low  $R_{DS(ON)}$  to minimize the conduction loss.

The SY8366A adopts the instant PWM architecture to achieve fast transient responses for high step down applications and high efficiency at light loads. In addition, it operates at pseudo-constant frequency of 800kHz under continuous conduction mode to minimize the size of inductor and capacitor.

### Ordering Information



Ordering Number	Package type	Note
SY8366AQQC	QFN3x3-12	--

### Features

- Low  $R_{DS(ON)}$  for internal switches (top/bottom): 40/20 mΩ
- Wide input voltage range: 4-28V
- Instant PWM architecture to achieve fast transient responses
- Internal 600us softstart limits the inrush current
- Pseudo-constant frequency: 800kHz.
- 6A continuous/12A peak output current capability
- $\pm 1.5\%$  0.6V reference
- Programmable peak current limit
- Power good indicator
- Output discharge function
- Hic-cup mode output short circuit protection
- Hic-cup mode output over voltage protection
- Input UVLO
- Over temperature protection
- RoHS Compliant and Halogen Free
- Compact package: QFN3x3-12

### Applications

- LCD-TV/Net-TV/3DTV
- Set Top Box
- Notebook
- High Power AP

### Typical Applications

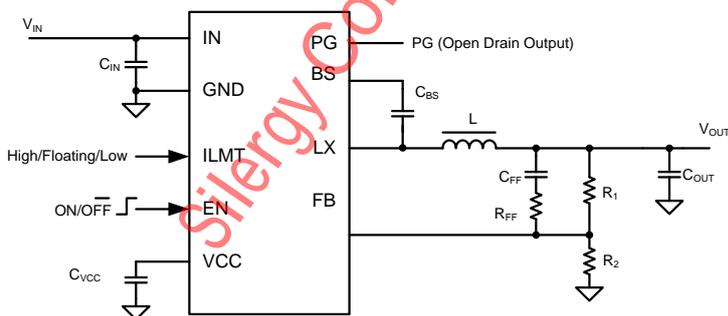


Figure 1 Schematic

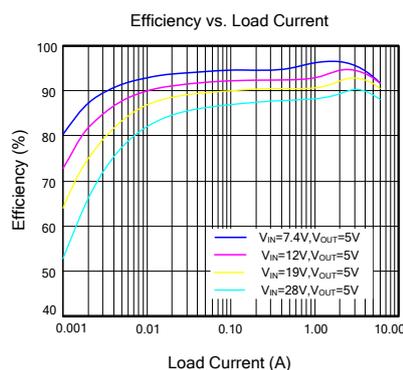
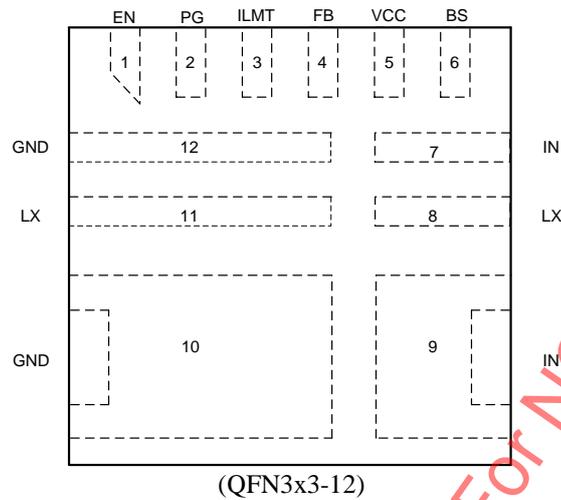


Figure 2. Efficiency

## Pinout (top view)



Top Mark: ATO<sub>xyz</sub>, (Device code: ATO, *x*=year code, *y*=week code, *z*=lot number code)

Pin Name	Pin Number	Pin Description
EN	1	Enable control. Pull this pin high to turn on the IC. Do not leave this pin floating.
PG	2	Power good Indicator. Open drain output when the output voltage is within 90% to 120% of regulation point.
ILMT	3	Current limit setting pin. The current limit is set to 6A, 9A or 12A when this pin is pull low, floating or pull high respectively.
FB	4	Output Feedback Pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{out}=0.6*(1+R1/R2)$
VCC	5	Internal 3.3V LDO output. Power supply for internal analog circuits and driving circuit. Bypass a capacitor to GND.
BS	6	Boot-Strap Pin. Supply high side gate driver. Decouple this pin to LX pin with 0.1uF ceramic cap.
IN	7,9	Input pin. Decouple this pin to GND pin with at least 10uF ceramic cap
GND	10,12	Ground pin
LX	8,11	Inductor pin. Connect this pin to the switching node of inductor

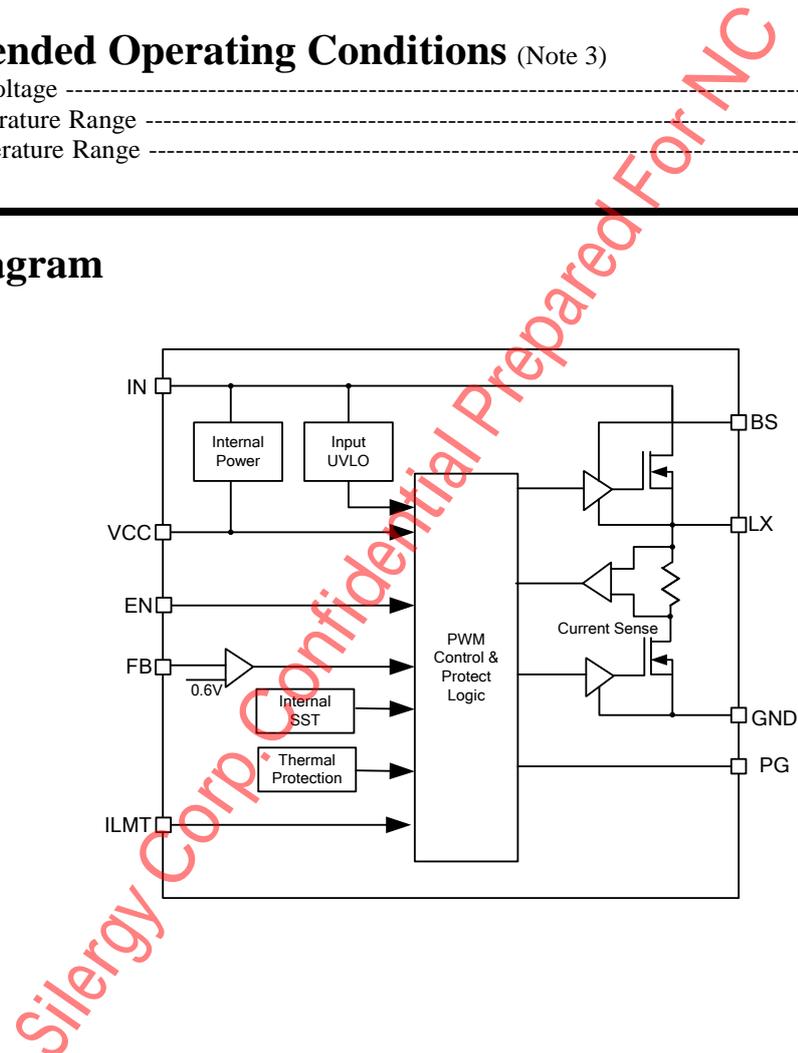
## Absolute Maximum Ratings (Note 1)

IN, LX, PG, EN	-----	30V
BS-LX, FB, ILMT, VCC	-----	4V
Power Dissipation, PD @ T <sub>A</sub> = 25 °C QFN3x3-12	-----	3.3W
Package Thermal Resistance (Note 2)		
θ <sub>JA</sub>	-----	30 °C/W
θ <sub>JC</sub>	-----	4 °C/W
Junction Temperature Range	-----	150 °C
Lead Temperature (Soldering, 10 sec.)	-----	260 °C
Storage Temperature Range	-----	-65 °C to 150 °C
Dynamic LX voltage in 10ns duration	-----	IN+3V to GND-5V

## Recommended Operating Conditions (Note 3)

Supply Input Voltage	-----	4V to 28V
Junction Temperature Range	-----	-40 °C to 150 °C
Ambient Temperature Range	-----	-40 °C to 85 °C

## Block Diagram



## Electrical Characteristics

( $V_{IN} = 12V$ ,  $V_{OUT} = 5V$ ,  $C_{OUT} = 100\mu F$ ,  $T_A = 25^\circ C$ ,  $I_{OUT} = 2A$  unless otherwise specified)

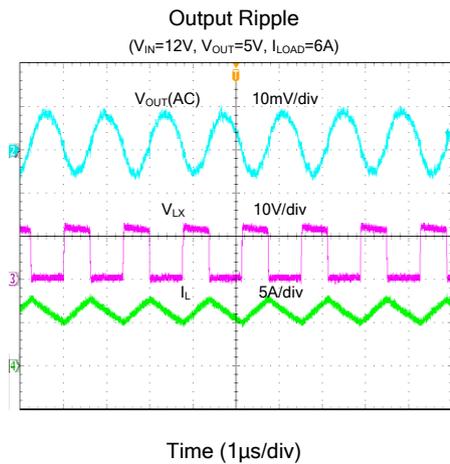
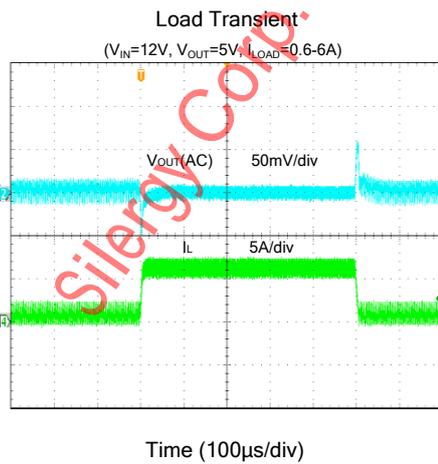
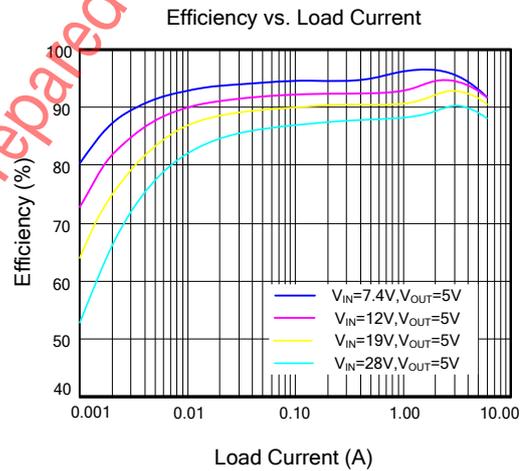
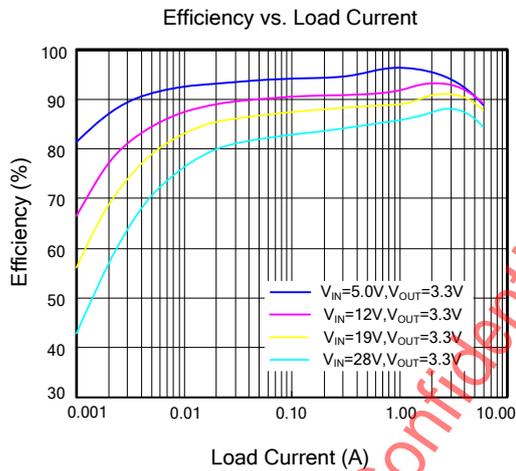
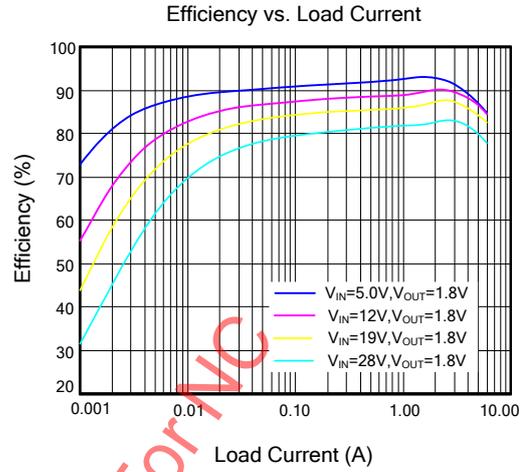
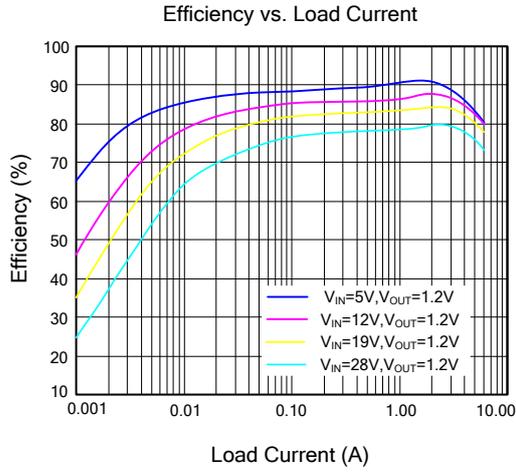
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	$V_{IN}$		4.0		28	V
Quiescent Current	$I_Q$	$I_{OUT} = 0$ , $V_{FB} = V_{REF} * 105\%$		100		$\mu A$
Shutdown Current	$I_{SHDN}$	$EN = 0$		3	10	$\mu A$
Feedback Reference Voltage	$V_{REF}$		0.591	0.6	0.609	V
FB Input Current	$I_{FB}$	$V_{FB} = 4V$	-50		50	nA
Top FET RON	$R_{ds(on)1}$			40		m $\Omega$
Bottom FET RON	$R_{ds(on)2}$			20		m $\Omega$
Discharge Current	$I_{DIS}$			100		mA
Bottom FET Current Limit	$I_{LIM}$	$ILMT = '0'$	6			A
		$ILMT = \text{Floating}$	9			
		$ILMT = '1'$	12			
ILMT Rising Threshold	$V_{ILMTH}$		$V_{CC} - 0.8$		$V_{CC}$	V
ILMT Falling Threshold	$V_{ILMTL}$				0.8	V
ILMT Floating Threshold	$V_{ILMIF}$		1.3		2	V
Soft Start Time	$T_{SS}$			600		$\mu s$
EN Rising Threshold	$V_{ENH}$		0.8			V
EN Falling Threshold	$V_{ENL}$				0.4	V
EN Leakage Current	$I_{EN}$		-1		1	$\mu A$
Input UVLO Threshold	$V_{UVLO}$				3.9	V
UVLO hysteresis	$V_{HYS}$			0.3		V
Oscillator Frequency	$F_{OSC}$	$V_O = 5V$	0.68	0.8	0.92	MHz
Min ON Time	$T_{ON,MIN}$	$V_{IN} = V_{IN,MAX}$		50		ns
Min OFF Time	$T_{OFF,MIN}$			180		ns
VCC Output	$V_{CC}$	$V_{IN} = 4V$	3.2	3.3	3.4	V
Output Over Voltage Threshold		$V_{FB}$ Rising	115	120	125	$\% V_{REF}$
Output Over Voltage Hysteresis				2		$\% V_{REF}$
Output Over Voltage Delay Time				20		$\mu s$
Power Good Threshold		$V_{FB}$ Rising	88	90	92	$\% V_{REF}$
Power Good Hysteresis				2		$\% V_{REF}$
Power Good Delay Time				10		$\mu s$
Thermal Shutdown Temperature	$T_{SD}$			150		$^\circ C$
Thermal Shutdown hysteresis	$T_{HYS}$			15		$^\circ C$

**Note 1:** Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

**Note 2:**  $\theta_{JA}$  is measured in the natural convection at  $T_A = 25^\circ C$  on a four-layer Silergy Evaluation Board..

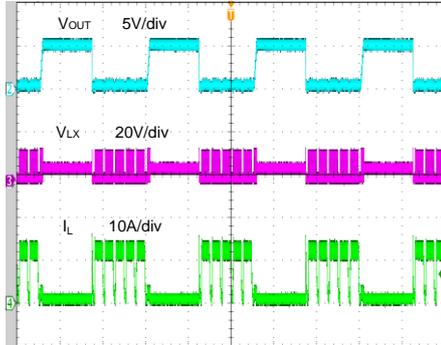
**Note 3:** The device is not guaranteed to function outside its operating conditions.

## Typical Performance Characteristics



### Short Circuit Protection

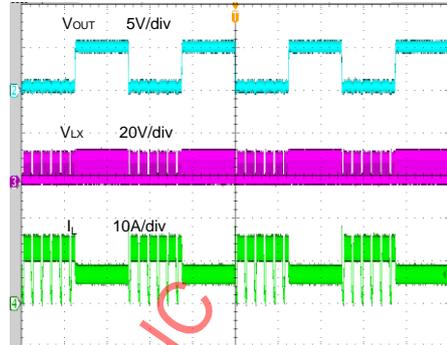
( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LIMIT}$  = Floating,  $I_{LOAD}=0$  to Short)



Time (4ms/div)

### Short Circuit Protection

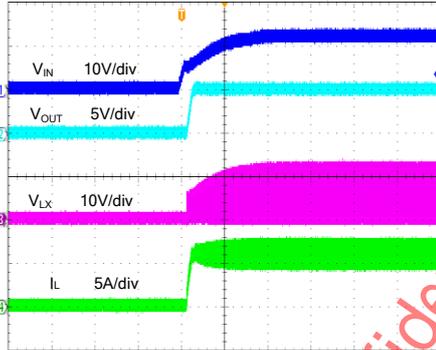
( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LIMIT}$  = Floating,  $I_{LOAD}=6A$  to Short)



Time (4ms/div)

### Startup from VIN

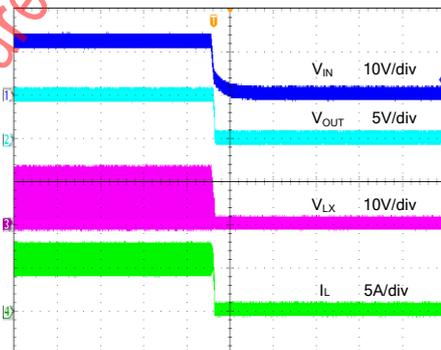
( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LOAD}=6A$ )



Time (2ms/div)

### Shutdown from VIN

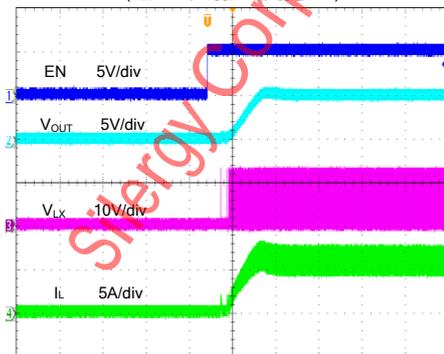
( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LOAD}=6A$ )



Time (10ms/div)

### Startup from Enable

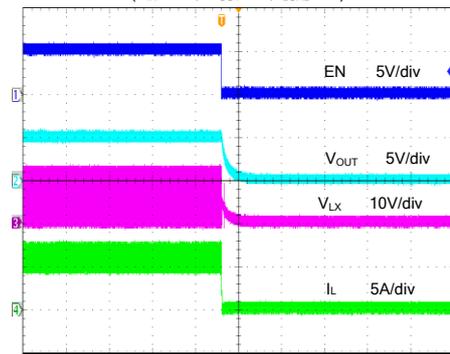
( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LOAD}=6A$ )



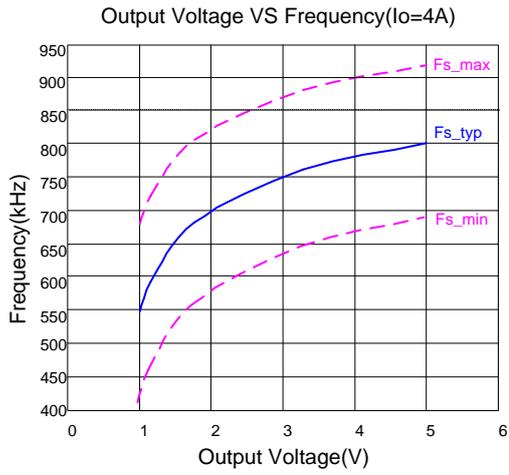
Time (400μs/div)

### Shutdown from Enable

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{LOAD}=6A$ )



Time (400μs/div)



Silergy Corp. Confidential Prepared For NC

## Operation

The SY8366A develops a high efficiency synchronous step-down DC-DC regulator capable of delivering 6A continuous, 12A peak current. The SY8366A operates over a wide input voltage range from 4V to 28V and integrates main switch and synchronous switch with very low  $R_{DS(ON)}$  to minimize the conduction loss.

The SY8366A adopts the instant PWM architecture to achieve fast transient responses for high step down applications and high efficiency at light loads. In addition, it operates at pseudo-constant frequency of 800kHz under continuous conduction mode to minimize the size of inductor and capacitor.

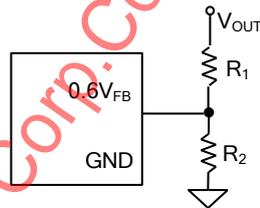
## Applications Information

Because of the high integration in the SY8366A IC, the application circuit based on this regulator IC is rather simple. Only input capacitor  $C_{IN}$ , output capacitor  $C_{OUT}$ , output inductor  $L$  and feedback resistors ( $R_1$  and  $R_2$ ) need to be selected for the targeted applications specifications.

### Feedback resistor dividers $R_1$ and $R_2$ :

Choose  $R_1$  and  $R_2$  to program the proper output voltage. To minimize the power consumption under light loads, it is desirable to choose large resistance values for both  $R_1$  and  $R_2$ . A value of between 10k $\Omega$  and 1M $\Omega$  is highly recommended for both resistors. If  $V_{out}$  is 3.3V,  $R_1=100k$  is chosen, then using following equation,  $R_2$  can be calculated to be 22.1k:

$$R_2 = \frac{0.6V}{V_{OUT} - 0.6V} R_1$$



### Input capacitor $C_{IN}$ :

The ripple current through input capacitor is calculated as:

$$I_{CIN\_RMS} = I_{OUT} \cdot \sqrt{D(1-D)}$$

To minimize the potential noise problem, place a typical X5R or better grade ceramic capacitor really close to the IN and GND pins. Care should be taken to minimize the loop area formed by  $C_{IN}$ , and IN/GND pins. In this case, a 10uF low ESR ceramic capacitor is recommended.

### Output capacitor $C_{OUT}$ :

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. For most applications, an X5R or better grade ceramic capacitor greater than 66uF capacitance can work well. The capacitance derating with DC voltage must be considered.

### Output inductor $L$ :

There are several considerations in choosing this inductor.

- 1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$L = \frac{V_{OUT}(1 - V_{OUT}/V_{IN,MAX})}{F_{SW} \times I_{OUT,MAX} \times 40\%}$$

where  $F_{sw}$  is the switching frequency and  $I_{OUT,MAX}$  is the maximum load current.

The SY8366A regulator IC is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

- 2) The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

$$I_{SAT, MIN} > I_{OUT, MAX} + \frac{V_{OUT}(1 - V_{OUT}/V_{IN,MAX})}{2 \cdot F_{SW} \cdot L}$$

- 3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with  $DCR < 10m\Omega$  to achieve a good overall efficiency.

### Current limit setting

The current limit is set to 6A, 9A or 12A when ILMT pin is pull low, floating or pull high respectively.

### Soft-start

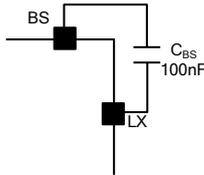
The SY8366A has a built-in soft-start to control the rise rate of the output voltage and limit the input current surge during IC start-up. The typical soft-start time is 600us.

### Enable Operation

Pulling the EN pin low ( $<0.4V$ ) will shut down the device. During shutdown mode, the SY8366A shutdown current drops to lower than  $10\mu A$ , driving the EN pin high ( $>0.8V$ ) will turn on the IC again.

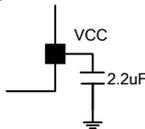
### External Bootstrap Cap

This capacitor provides the gate driver voltage for internal high side MOSEFET. A  $100nF$  low ESR ceramic capacitor connected between BS pin and LX pin is recommended.



### VCC LDO

The  $3.3V$  VCC LDO provides the power supply for internal control circuit. Bypass this pin to ground with a  $2.2\mu F$  ceramic capacitor.



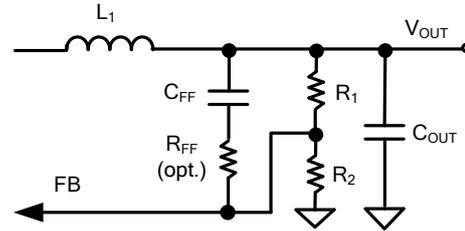
### Power Good Indication

PG is an open drain output. This pin is externally pulled high when the FB voltage is within 90% to 120% of the internal reference voltage. Otherwise is pulled low.

### Load Transient Considerations:

The SY8366A regulator IC adopts the instant PWM architecture to achieve good stability and fast transient responses. In applications with high step load current, adding an RC network  $R_{FF}$  and  $C_{FF}$  parallel with  $R_1$

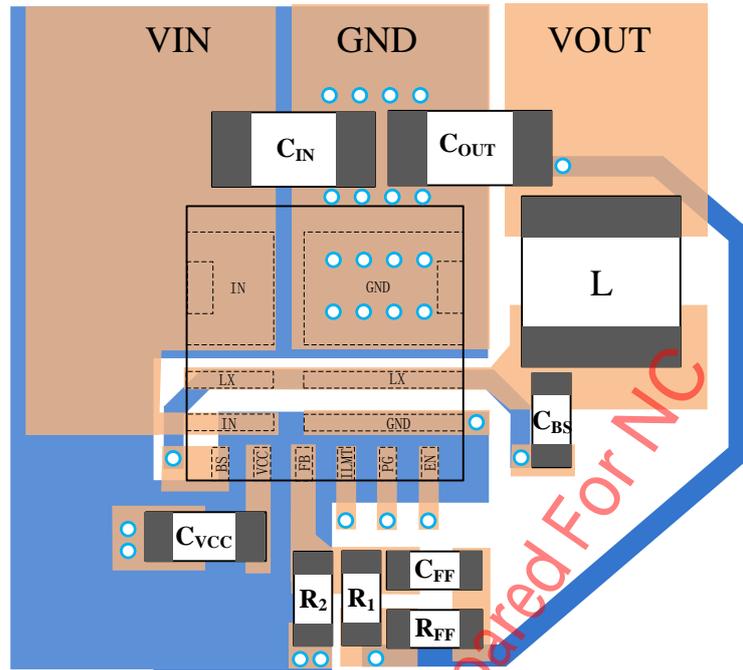
may further speed up the load transient responses.



### Layout Design:

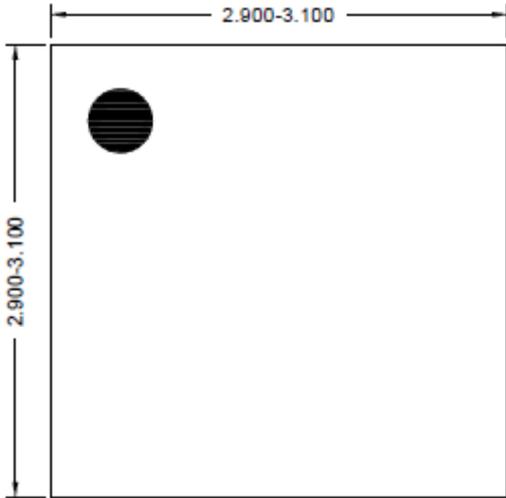
The layout design of SY8366A regulator is relatively simple. For the best efficiency and minimum noise problem, we should place the following components close to the IC:  $C_{IN}$ ,  $C_{VCC}$ , L,  $R_1$  and  $R_2$ .

- 1) It is desirable to maximize the PCB copper area connecting to GND pin to achieve the best thermal and noise performance. If the board space allowed, a ground plane is highly desirable.
- 2)  $C_{IN}$  must be close to pins IN and GND. The loop area formed by  $C_{IN}$  and GND must be minimized.
- 3) The PCB copper area associated with LX pin must be minimized to avoid the potential noise problem.
- 4) The components  $R_1$ ,  $R_2$ , and the trace connecting to the FB pin must NOT be adjacent to the LX net on the PCB layout to avoid the noise problem.
- 5) If the system chip interfacing with the EN pin has a high impedance state at shutdown mode and the IN pin is connected directly to a power source such as a Li-Ion battery, it is desirable to add a pull down  $1M\Omega$  resistor between the EN and GND pins to prevent the noise from falsely turning on the regulator at shutdown mode.



Silergy Corp. Confidential Prepared For NC

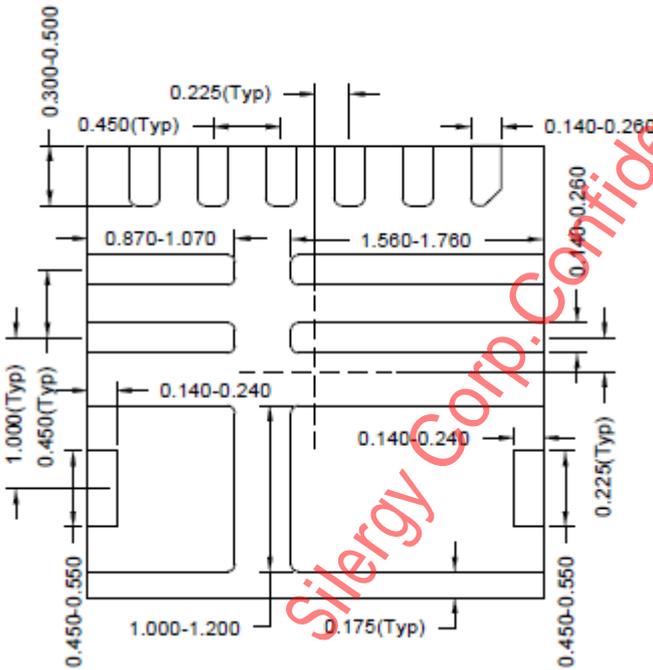
## QFN3x3-12 Package Outline Drawing



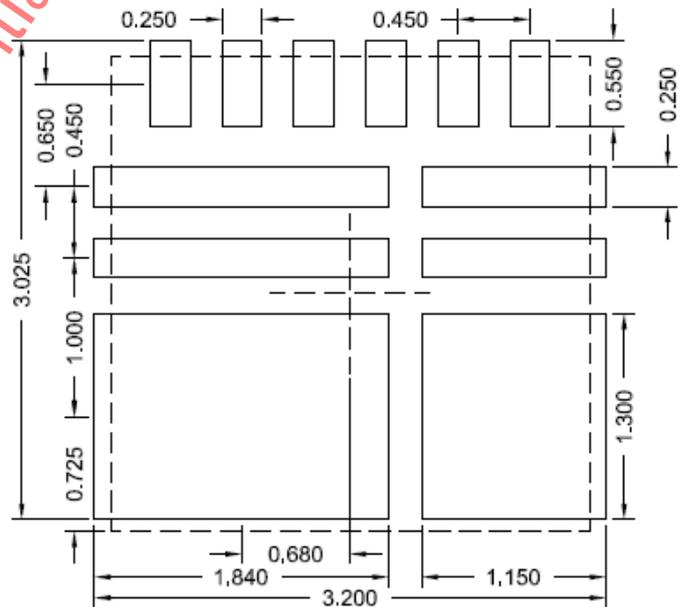
Top View



Side View



Bottom View

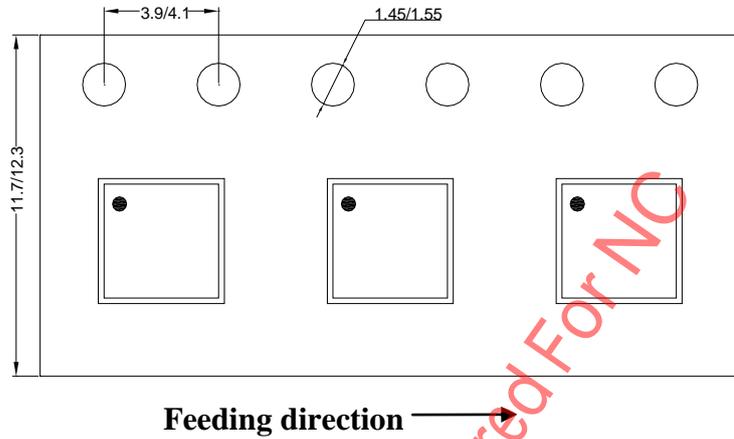


Recommended PCB layout  
(Reference Only)

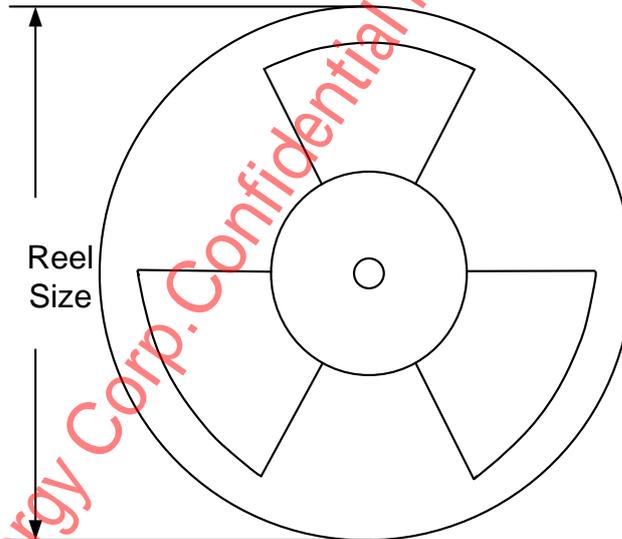
**Notes:** All dimension in MM and exclude mold flash & metal burr.

## Taping & Reel Specification

### 1. QFN3x3-12 taping orientation



### 2. Carrier Tape & Reel specification for packages



Package types	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
QFN3x3	12	8	13"	400	400	5000

### 3. Others: NA

**IMPORTANT NOTICE**

- 1. Right to make changes.** Silergy and its subsidiaries (hereafter Silergy) reserve the right to change any information published in this document, including but not limited to circuitry, specification and/or product design, manufacturing or descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to Silergy's standard terms and conditions of sale.
- 2. Applications.** Application examples that are described herein for any of these products are for illustrative purposes only. Silergy makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Buyers are responsible for the design and operation of their applications and products using Silergy products. Silergy or its subsidiaries assume no liability for any application assistance or designs of customer products. It is customer's sole responsibility to determine whether the Silergy product is suitable and fit for the customer's applications and products planned. To minimize the risks associated with customer's products and applications, customer should provide adequate design and operating safeguards. Customer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Silergy assumes no liability related to any default, damage, costs or problem in the customer's applications or products, or the application or use by customer's third-party buyers. Customer will fully indemnify Silergy, its subsidiaries, and their representatives against any damages arising out of the use of any Silergy components in safety-critical applications. It is also buyers' sole responsibility to warrant and guarantee that any intellectual property rights of a third party are not infringed upon when integrating Silergy products into any application. Silergy assumes no responsibility for any said applications or for any use of any circuitry other than circuitry entirely embodied in a Silergy product.
- 3. Limited warranty and liability.** Information furnished by Silergy in this document is believed to be accurate and reliable. However, Silergy makes no representation or warranty, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. In no event shall Silergy be liable for any indirect, incidental, punitive, special or consequential damages, including but not limited to lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges, whether or not such damages are based on tort or negligence, warranty, breach of contract or any other legal theory. Notwithstanding any damages that customer might incur for any reason whatsoever, Silergy' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Standard Terms and Conditions of Sale of Silergy.
- 4. Suitability for use.** Customer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of Silergy components in its applications, notwithstanding any applications-related information or support that may be provided by Silergy. Silergy products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Silergy product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Silergy assumes no liability for inclusion and/or use of Silergy products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.
- 5. Terms and conditions of commercial sale.** Silergy products are sold subject to the standard terms and conditions of commercial sale, as published at <http://www.silergy.com/stdterms>, unless otherwise agreed in a valid written individual agreement specifically agreed to in writing by an authorized officer of Silergy. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Silergy hereby expressly objects to and denies the application of any customer's general terms and conditions with regard to the purchase of Silergy products by the customer.
- 6. No offer to sell or license.** Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights. Silergy makes no representation or warranty that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right. Information published by Silergy regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from Silergy under the patents or other intellectual property of Silergy.

For more information, please visit: [www.silergy.com](http://www.silergy.com)

© 2018 Silergy Corp.

All Rights Reserved.